

FINAL 06/03/2023

Joint Declaration
on the foundation of an
European Semiconductor Regions Alliance

between

the Centro Region, Portuguese Republic

and

the Region of the Basque Country, Kingdom of Spain

and

the Free State of Bavaria, Federal Republic of Germany

and

the Region of Flanders, the Kingdom of Belgium

and

the Federal Province of Carinthia, Republic of Austria

and

the Region of Catalonia, Kingdom of Spain

and

the South Moravian Region, Czech Republic

and

the Province of Overijssel, the Kingdom of the Netherlands

and

the Region of Piedmont, the Italian Republic

and

the region of Provence-Alpes-Côte d'Azur, French Republic

and

the Free State of Saxony, Federal Republic of Germany

and

the Province of Styria, Republic of Austria

We, the undersigned European countries and regions (hereafter "sides"), recognise the importance of the semiconductor industry to the economic development of our countries, regions and Europe as a whole and wish to promote and deepen cooperation between our regions. Therefore, we hereby declare our intention to establish an Alliance of European Semiconductor Regions.

The objective of the proposed Alliance is to promote the growth and competitiveness of the semiconductor industry in our regions and in Europe by sharing knowledge and best practices, fostering collaboration and innovation, and supporting the development of a strong and integrated value chain. In doing so, it shall actively contribute to the implementation of the EU Chip Law.

The Alliance shall focus its activities on the following areas:

- Research and innovation, including the development of new technologies and applications, and the promotion of technology transfer and commercialisation.
- Skills and talent development, including the promotion of education and training programmes and the attraction and retention of talent in our regions.
- Cluster development and collaboration, including the promotion of regional clusters and the creation of cross-regional partnerships and collaborations.

The Alliance shall act as a platform for the exchange of information and best practices and facilitate cooperation between its members in areas of common interest. The Alliance shall also promote the interests of its members and the semiconductor industry to European and international organisations and stakeholders.

In particular, this Memorandum of Understanding shall not constitute a treaty under international law and shall not create any rights or obligations under international law. Each side will bear any costs it incurs in connection with this Memorandum of Understanding. In particular, this declaration does not create any obligation to establish an alliance of European semiconductor regions.

However, it is the common objective of the signatory parties to establish the Alliance within the next twelve months from the date of signature. The Alliance is currently planned to be led by a Steering Committee composed of representatives of the Sides, which will meet regularly to discuss and coordinate their activities.

Signed in Brussels on 6 March 2023, in English.